1. Scope of Application

Non-coded : Bulk T : Taping (standard)

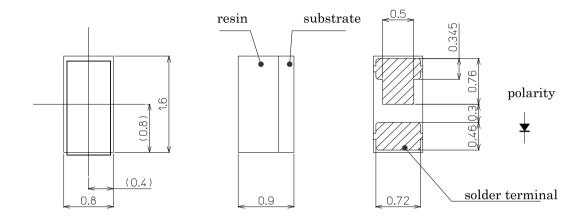
These specifications are applied to the chip type LED lamp, model CL-824-MU1L1-T

2. Part code

CL-824-MU1L1-T
Series ————————————————————————————————————
Special specifications — M: General Color Rendering Index Typ. 85 Type.
Watt Class U1: Under 1 watt package.
Lighting color L1: Energy Star Correlated Color Temperature 3000(K)
Shinning mode

			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	
	2009/6/5	Issue of first edition				Diawing No	
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3. Outline drawing



4. Performance

(1) Absolute Maximum Rating

1 / Thosolate Maximum Hatim	5			_
Parameter	Symbol	Rating Value	Unit	
Power Dissipation	Pd	108	mW	
Forward Current	${ m I_F}$	30	mA	
Forward Pulse Current	I_{FP}	100	mA	*1
Reverse Voltage	V_{R}	5	V	
Operating Temperature	T_{OP}	-30 ~ +85	C	
Storage Temperature	T_{ST}	-40 ~ +100	C	
Junction Temperature	Tj _{Max}	120	C	*2

^{*1}Forward Current : Duty≤1/10 , Pulse Width≤0.1msec

*2 D.C. Current : Tj = Tc + Rj-s x Pd Pulse Current : Tj = Tc + Rj-s x Pw(Power Dissipation / one-Pulse) x duty *Tc:Temperature of anode solder terminal

			Approved	Checked	Drawn	Symbol	CITILED
		_				Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	
	2009/6/5	Issue of first edition				Drawing No	
Mark	Date	Description Appro.	CITIZEN ELECTRONICS CO.,LTD.				

(2) Electro-optical Characteristics

(Tc=25C)

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Forward Voltage	V_{F}	I_F =20mA	2.8	3.2	3.5	V
Reverse Current	I_R	$V_R=5V$	-	-	100	μA
Thermal resistance	$R_{j \cdot s}$	Junction-solder	•	175	-	C/W
Luminous Intensity*1	I_{v}	I_F =20mA	1100	1670	-	mcd
Luminous Flux	$\phi_{ m V}$	I_F =20mA	•	(4.6)	-	lm
General Color Rendering Index	Ra	I_F =20mA	80	85	-	-

^{*1} In accordance with NIST standard

Ranking (Condition: I_F=20mA, Tc=25C)

Parameter	Symbol	Rank	MIN	MAX	Unit	
		Q	2.8	3.0	V	
Forward Voltage	$ m V_{F}$	R	3.0	3.2		
		\mathbf{S}	3.2	3.5		
	$I_{\rm v}$	В	1100	1251		
Luminous Intensity		С	1251	1693	mcd	
		D	1693	2291		

Chromaticity coordinates

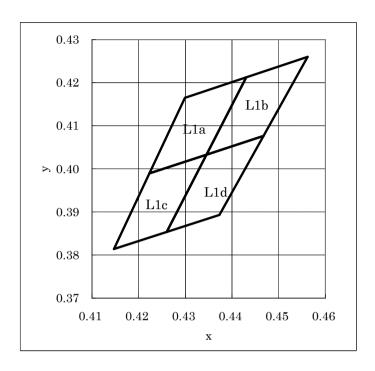
(Condition : I_F =20mA , T_C =25C)

Color Rank	X	у	Color Rank	X	y
	0.4431	0.4213		0.4562	0.4260
T.10	0.4299	0.4165	L1b	0.4431	0.4213
L1a	0.4223	0.3990	P10	0.4345	0.4033
	0.4345	0.4033		0.4468	0.4077

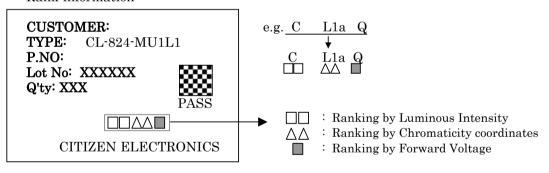
Color Rank	X	у	Color Rank	X	y
	0.4345	0.4033		0.4468	0.4077
T 10	0.4223	0.3990	T 1 J	0.4345	0.4033
L1c	0.4147	0.3814	L1d	0.4260	0.3854
	0.4260	0.3854		0.4373	0.3893

Note 1) The tolerance of measurement at our tester is $V_F\pm3\%$, $\phi v\pm10\%$, Chromaticity(x,y) ±0.01 . Note 2) For handling ,please apply CMOS LSI or equivalent any electrostatic effect.

			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	T-
	2009/6/5	Issue of first edition				Drawing No	
Mark	Date	Description Appro.	CITIZEN ELECTRONICS CO.,LTD.				



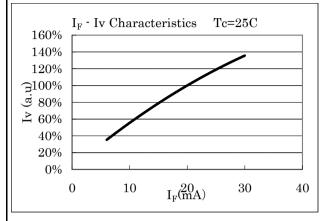
Rank information



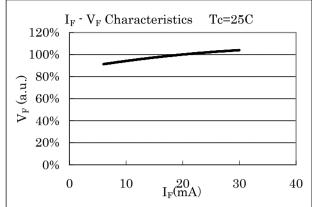
			Approved	Checked	Drawn	Symbol	CITILED
			-			Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	
	2009/6/5	Issue of first edition				Drawing No	
Mark	Date	Description Appro.		CITIZE	N ELECT	RONICS (CO.,LTD.

5. Characteristics

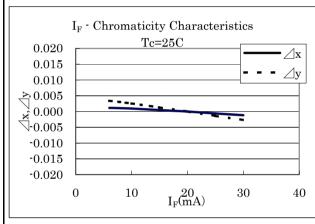
Forward Current vs. Relative Luminous Intensity



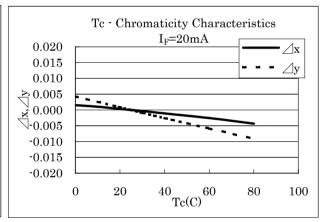
Forward Current vs. Forward Voltage



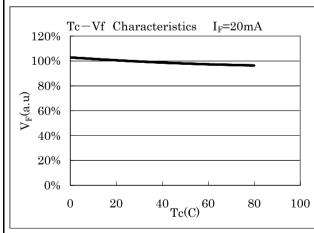
Forward Current vs. Chromaticity Coordinate



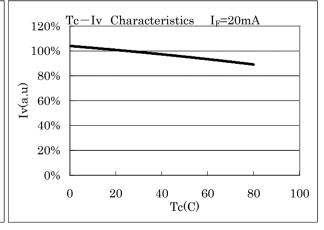
Case Temperature vs. Chromaticity Coordinate



Case Temperature vs. Forward Voltage

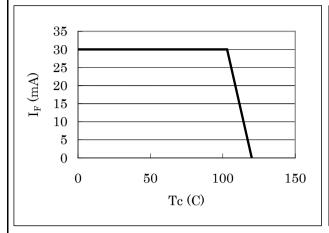


Case Temperature vs. Relative Luminous Intensity

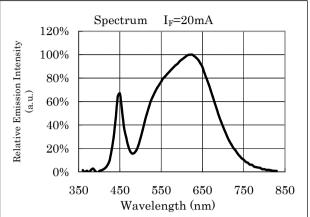


			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	
	2009/6/5	Issue of first edition				Drawing No	
Mark	Date	Description Appro.		CITIZE	N ELECT	RONICS (CO.,LTD.

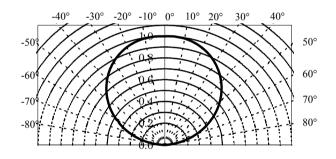
Case Temperature vs. Allowable Forward Current



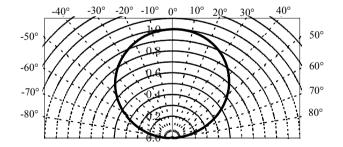
Spectrum



Directive Characteristic









*Measurement condition (directive characteristic) LED chip is mounted on black color PCB.

			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	
	2009/6/5	Issue of first edition				Drawing No	
Mark	Date	Description Appro.	CITIZEN ELECTRONICS CO.,LTD.				

6. Reliability

(1)Details of the tests

Test Item	Test Condition
Life Test in Continuous Operation	25±3C, $\rm I_F\!\!=\!\!20~mA$, $\rm 1000_{+24/\text{-}12}hours$
Low Temperature Storage Test	-40 _{+3/-5} C , 1000 _{+24/-12} hours
High Temperature Storage Test	$100_{+5/-3}{ m C}$, $1000_{+24/-12}{ m hours}$
Moisture-proof Test	60 ± 2 C, $90 \pm 5\%$ RH for $1000_{+24/\cdot 12}$ hours
Thermal Shock Test	-40C . 30 minutes and 100C , 30 minutes, 100cycle
Solder Heat Resistance Test	Recommended temperature profile (reflow soldering) × 2, (2nd test must be started after the samples are stabilized thermally.)

(2) Judgment Criteria of Failure for Reliability Test

(Ta=25C)

Measuring Item	Symbol	Measuring Condition	Judgement Criteria for Failure
Forward Voltage	V_{F}	$I_F=20 mA$	>U×1.2
Reverse Current	I_{R}	$V_R=5V$	>U×2
Luminous Intensity	I_V	I_F =20mA	<s×0.7< td=""></s×0.7<>

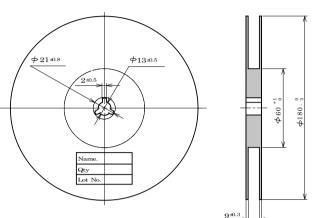
U defines the upper limit of the specified characteristics.S defines the initial value.

Note: Measurement shall be taken between 2 hours and 24 hours, and the test pieces should be returned to the normal ambient conditions after the completion of each test.

			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	
	2009/6/5	Issue of first edition				Drawing No	
Mark	Date	Description Appro.	CITIZEN ELECTRONICS CO.,LTD.				

7. Taping Specifications (in accordance with JIS standard)

(1) Shape and Dimensions of Reel

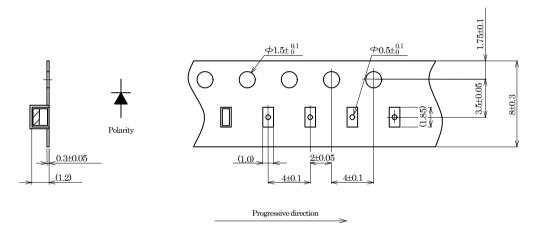


11.4^{±1.0}

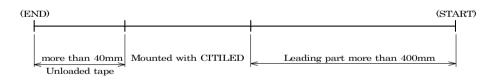
(2) Dimensions of Tape



(Unit: mm)



(3) Configuration of Tape



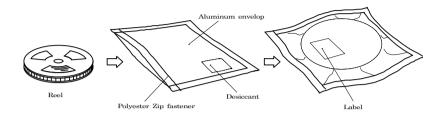
(4) Quantity: 2500pcs/reel

			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Duarring Ma	
	2009/6/5	Issue of first edition				Drawing No	
Mark	Date	Description Appro.	CITIZEN ELECTRONICS CO.,LTD.				

8. Packing Specifications

8-1. Moisture-proof Packing

To prevent moisture absorption during transportation and storage, reels are packed in aluminum envelopes which contain a desiccant with a humidity indicator.



8-2. Storage

To prevent moisture absorption, it is strongly recommended that reels (in bulk or taped) should be stored in the dry box (or the desiccator) with a desiccant as the appropriate storage place. If not, the following is recommended.

Temperature: $5 \sim 30 \text{ C}$ Humidity: 60%RH max

The devices should be mounted as soon as possible after unpacking. If you store the unpacked reels, please store them in the dry box or seal them into the envelop again.

MSL 1 (IPC/JEDEC J-STD-020C)

			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	
	2009/6/5	Issue of first edition				Drawing No	
Mark	Date	Description Appro.	CITIZEN ELECTRONICS CO.,LTD.				

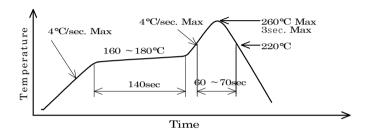
9. Precautions

9-1. Soldering

(1) Lead free soldering

1) Following soldering paste is recommended Melting temperature: $216 \sim 220C$ Composition: Sn 3.5Ag 0.75Cu

- 2) The temperature profile at the top surface of the parts is recommended as shown below.
- 3) It is requested that products should be handled after their temperature has dropped down to the normal room temperature



9-2. Washing

- (1) When washing after soldering is needed, following conditions are requested.
- a) Washing solvent: Pure Water
- b) Temperature, time: $50\mathrm{C}$ or less \times 30 seconds max. or $30\mathrm{C}$ or less \times 3 minutes max.
- c) Ultrasonic washing: 300W or less

9-3. Other directions

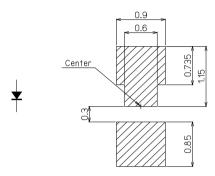
- (1) It is requested to avoid any stress added to the resin portion while it is heated.
- (2) It is requested to avoid any friction by sharp metal nail etc. to the resin portion.

			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	
	2009/6/5	Issue of first edition				Drawing No	
Mark	Date	Description Appro.	CITIZEN ELECTRONICS CO.,LTD.				

10. Designing precautions

- (1) The current limiting resistor should be placed in the circuit so that is driven within its rating. Also avoid reverse voltage (over-current) applied instantaneously when ON or OFF.
- (2) When pulse driving current is applied, average current consumption should be within the rating. Also avoid reverse voltage applied when put off.
- (3) Recommended soldering pattern

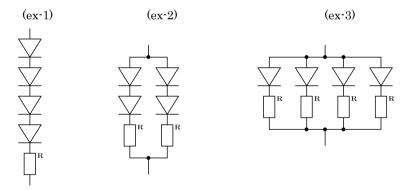
<For reflow soldering>



Unit: mm

The above dimensions are not the one which guarantee the performance of mount ability. The use of the above pattern is recommended to use after deep study at your site.

- (4) When assembling the circuit board into the finished products, care must be taken to avoid the component parts from touching other parts.
- (5) When using multiple LEDs, it is required to connect a current limiting resistor on each path which the current flows to the LEDs.



- (6) Other
- 1) This product complies with RoHS directives.
- 2) When this product is secondarily fabricated such as change in shape, it is not included in our warranty.
- 3) The agreement of formal product specification is required prior to mass production.

			Approved	Checked	Drawn	Symbol	CITILED
						Name	CL-824-MU1L1
	2009/7/29	Issue of second edition				Drawing No	
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